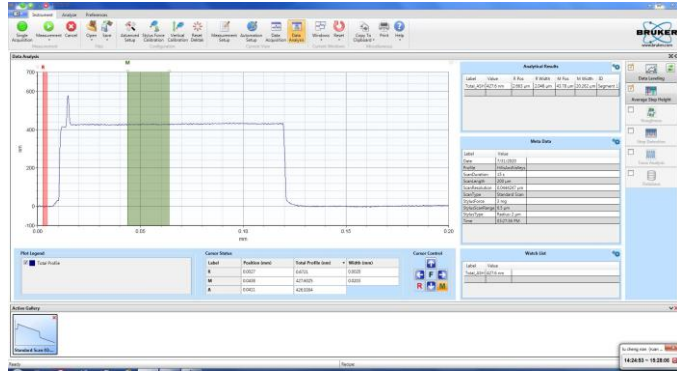
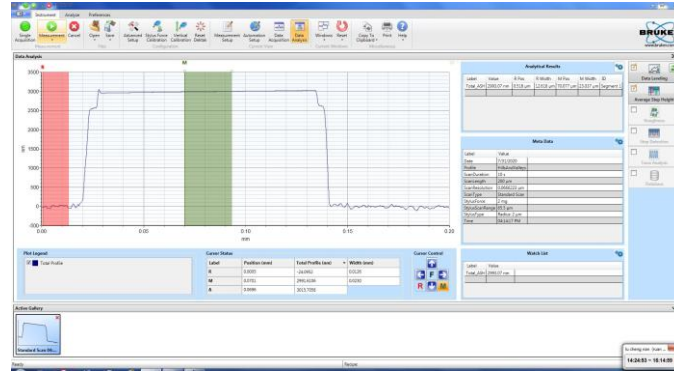


Dektak KOH etch , Sample Name: Gaozhen 100

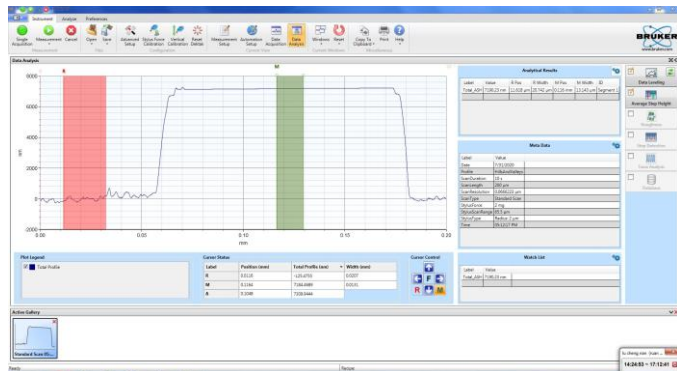
0min



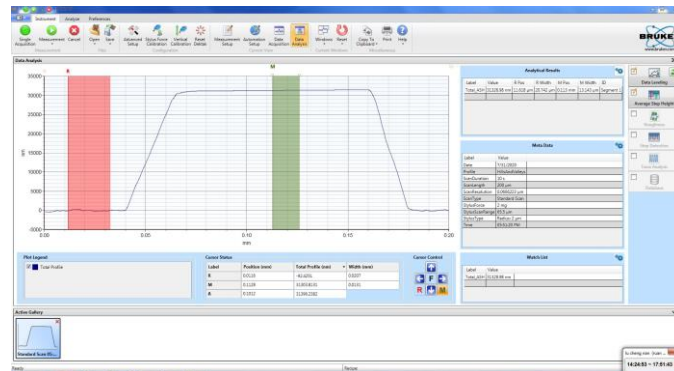
2min



5min

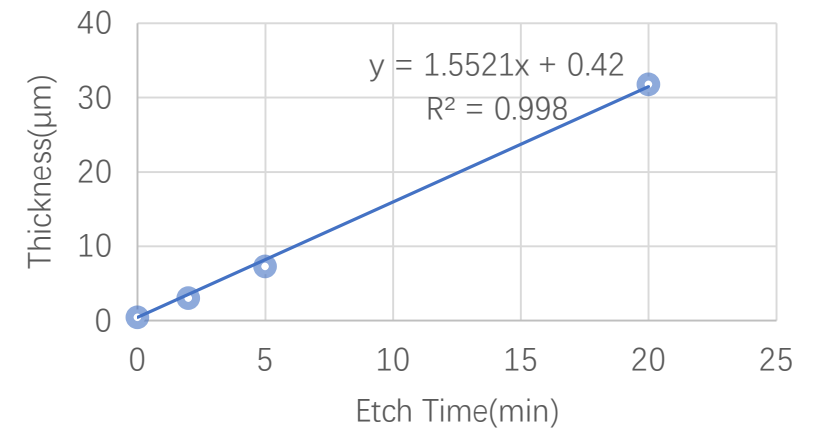


20min



Etch time(min)	Thickness -1(µm)	Thickness -2(µm)	Thicknes s-3(µm)	Thicknes s-4(µm)	Thickness -5(µm)	Average(µm)
0	0.4276	0.4246	0.41839	0.41551	0.41933	0.421086
2	2.99307	2.9619	2.89578	3.03372	2.97382	2.971658
5	7.19023	7.32853	7.05807	7.35936	7.36024	7.259286
20	31.32898	31.69817	31.78101	31.90323	32.02319	31.746916

Etch Rate



25% KOH @80°C

Etch Rate(100 wafer): 1.55µm/min